

## **Application Data Sheet**

### **Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R??::

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)?::

Number of copies of CRF::

Title:: A METHOD AND STRUCTURE FOR LAYOUT OF  
CELL CONTACT AREA FOR SEMICONDUCTOR  
INTEGRATED CIRCUITS

Attorney Docket Number:: 021653-003500US

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 4

Small Entity?:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.: No

**Applicant Information**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Republic of China  
Status:: Full Capacity  
Given Name:: Chia Te  
Middle Name::  
Family Name:: Wu  
Name Suffix::  
City of Residence:: Shanghai  
State or Province of Residence::  
Country of Residence:: Peoples Republic of China  
Street of Mailing Address:: 18 Zhang Jiang Rd.  
Postal Address Line Two:: Pudong New Area  
City of Mailing Address:: Shanghai  
State or Province of mailing address::  
Country of mailing address:: Peoples Republic of China  
Postal or Zip Code of mailing address:: 201203

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Peoples Republic of China  
Status:: Full Capacity  
Given Name:: Jian-Xiang  
Middle Name::  
Family Name:: Cai  
Name Suffix::  
City of Residence:: Shanghai  
State or Province of Residence::  
Country of Residence:: Peoples Republic of China  
Street of Mailing Address:: 18 Zhang Jiang Rd.

Postal Address Line Two:: Pudong New Area  
City of Mailing Address:: Shanghai  
State or Province of mailing address::  
Country of mailing address:: Peoples Republic of China  
Postal or Zip Code of mailing address:: 201203

### **Correspondence Information**

Correspondence Customer Number:: 20350

### **Representative Information**

Representative Customer Number:: 20350

### **Domestic Priority Information**

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

### **Foreign Priority Information**

Country:: Application number:: Filing Date::  
People's Republic of China 200310122971.5 12/30/03

### **Assignee Information**

Assignee Name:: Semiconductor Manufacturing International (Shanghai) Corporation  
Street of mailing address:: 18 Zhang Jiang Road, Pudong New Area  
City of mailing address:: Shanghai  
State or Province of mailing address::  
Country of mailing address:: People's Republic of China  
Postal or Zip Code of mailing address:: 201203